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## MECHANICAL OUTLINE

PRINT VERSION NOT TO SCALE

TITLE:

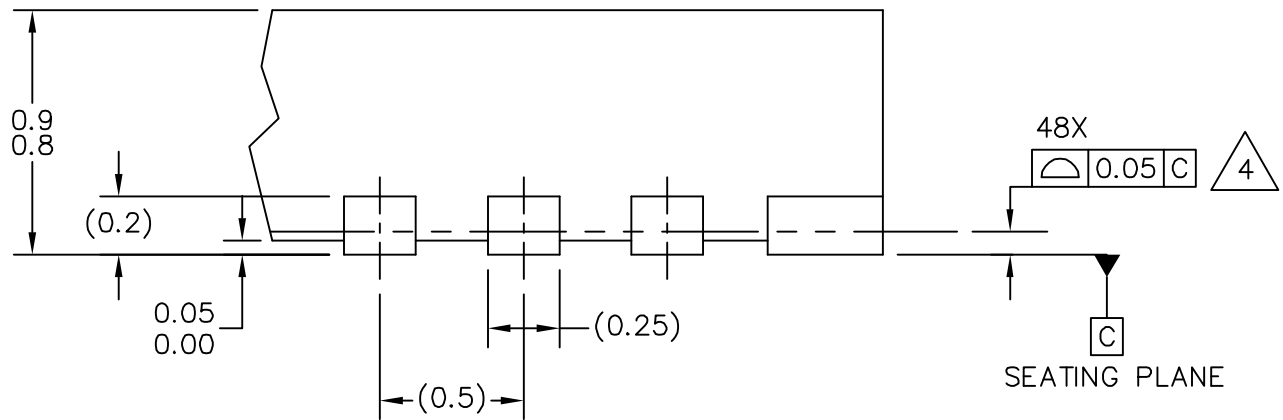
QFN, THERMALLY ENHANCED,  
7 X 7 X 0.85, 0.5 PITCH, 48 TERMINAL

DOCUMENT NO: 98ASA00719D

REV: B

STANDARD: NON-JEDEC

27 JUN 2014



DETAIL G  
VIEW ROTATED 90°CW

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		STANDARD: NON-JEDEC	
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NOTES:

1. ALL DIMENSIONS ARE IN MILLIMETERS.
2. DIMENSIONING AND TOLERANCING PER ASME Y14.5M–1994.
3. THIS IS A NON–JEDEC REGISTERED PACKAGE.

△4. COPLANARITY APPLIES TO LEADS AND DIE ATTACH FLAG.

△5. DIMENSION APPLIES TO METALLIZED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.3 MM FROM TERMINAL TIP. IF THE TERMINAL HAS THE OPTIONAL RADIUS ON THE OTHER END OF THE TERMINAL, THE DIMENSION SHOULD NOT BE MEASURED IN THAT RADIUS AREA.

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